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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

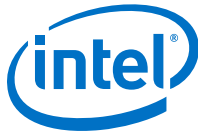
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Active  |
| Number of LABs/CLBs            | 339620  |
| Number of Logic Elements/Cells | 900000  |
| Total RAM Bits                 | 59234304  |
| Number of I/O                  | 768   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.87V ~ 0.98V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | -40°C ~ 100°C (TJ)  |
| Package / Case                 | 1932-BBGA, FCBGA  |
| Supplier Device Package        | 1932-FCBGA (45x45)  |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/10ax090n2f45i2sg">https://www.e-xfl.com/product-detail/intel/10ax090n2f45i2sg</a> |



| Feature                                 | Description   |  |
|---|---|--|
| Low-power serial transceivers           | <ul style="list-style-type: none"><li>Continuous operating range:<ul style="list-style-type: none"><li>Intel Arria 10 GX—1 Gbps to 17.4 Gbps</li><li>Intel Arria 10 GT—1 Gbps to 25.8 Gbps</li></ul></li><li>Backplane support:<ul style="list-style-type: none"><li>Intel Arria 10 GX—up to 12.5</li><li>Intel Arria 10 GT—up to 12.5</li></ul></li><li>Extended range down to 125 Mbps with oversampling</li><li>ATX transmit PLLs with user-configurable fractional synthesis capability</li><li>Electronic Dispersion Compensation (EDC) support for XFP, SFP+, QSFP, and CFP optical module</li><li>Adaptive linear and decision feedback equalization</li><li>Transmitter pre-emphasis and de-emphasis</li><li>Dynamic partial reconfiguration of individual transceiver channels</li></ul> |  |
| HPS<br>(Intel Arria 10 SX devices only) | Processor and system  | <ul style="list-style-type: none"><li>Dual-core ARM Cortex-A9 MPCore processor—1.2 GHz CPU with 1.5 GHz overdrive capability</li><li>256 KB on-chip RAM and 64 KB on-chip ROM</li><li>System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers</li><li>Security features—anti-tamper, secure boot, Advanced Encryption Standard (AES) and authentication (SHA)</li><li>ARM CoreSight* JTAG debug access port, trace port, and on-chip trace storage</li></ul>   |
|   | External interfaces   | <ul style="list-style-type: none"><li>Hard memory interface—Hard memory controller (2,400 Mbps DDR4, and 2,133 Mbps DDR3), Quad serial peripheral interface (QSPI) flash controller, NAND flash controller, direct memory access (DMA) controller, Secure Digital/MultiMediaCard (SD/MMC) controller</li><li>Communication interface— 10/100/1000 Ethernet media access control (MAC), USB On-The-Go (OTG) controllers, I<sup>2</sup>C controllers, UART 16550, serial peripheral interface (SPI), and up to 62 HPS GPIO interfaces (48 direct-share I/Os)</li></ul>   |
|   | Interconnects to core   | <ul style="list-style-type: none"><li>High-performance ARM AMBA* AXI bus bridges that support simultaneous read and write</li><li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li><li>Configuration bridge that allows HPS configuration manager to configure the core logic via dedicated 32-bit configuration port</li><li>FPGA-to-HPS SDRAM controller bridge—provides configuration interfaces for the multiport front end (MPFE) of the HPS SDRAM controller</li></ul> |
| Configuration                           | <ul style="list-style-type: none"><li>Tamper protection—comprehensive design protection to protect your valuable IP investments</li><li>Enhanced 256-bit advanced encryption standard (AES) design security with authentication</li><li>Configuration via protocol (CvP) using PCIe Gen1, Gen2, or Gen3</li></ul>   |  |
| continued...                            |   |  |

<sup>(2)</sup> Intel Arria 10 devices support this external memory interface using hard PHY with soft memory controller.



| Feature            | Description   |
|--------------------|---|
|                    | <ul style="list-style-type: none"><li>Dynamic reconfiguration of the transceivers and PLLs</li><li>Fine-grained partial reconfiguration of the core fabric</li><li>Active Serial x4 Interface</li></ul>   |
| Power management   | <ul style="list-style-type: none"><li>SmartVID</li><li>Low static power device options</li><li>Programmable Power Technology</li><li>Intel Quartus Prime integrated power analysis</li></ul>  |
| Software and tools | <ul style="list-style-type: none"><li>Intel Quartus Prime design suite</li><li>Transceiver toolkit</li><li>Platform Designer system integration tool</li><li>DSP Builder for Intel FPGAs</li><li>OpenCL™ support</li><li>Intel SoC FPGA Embedded Design Suite (EDS)</li></ul> |

### Related Information

#### [Intel Arria 10 Transceiver PHY Overview](#)

Provides details on Intel Arria 10 transceivers.

## Intel Arria 10 Device Variants and Packages

**Table 4. Device Variants for the Intel Arria 10 Device Family**

| Variant           | Description   |
|-------------------|---|
| Intel Arria 10 GX | FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.  |
| Intel Arria 10 GT | FPGA featuring: <ul style="list-style-type: none"><li>17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.</li><li>25.8 Gbps transceivers for supporting CAUI-4 and CEI-25G applications with CFP2 and CFP4 modules.</li></ul> |
| Intel Arria 10 SX | SoC integrating ARM-based HPS and FPGA featuring 17.4 Gbps transceivers for short reach applications with 12.5 backplane driving capability.  |

## Intel Arria 10 GX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

### Related Information

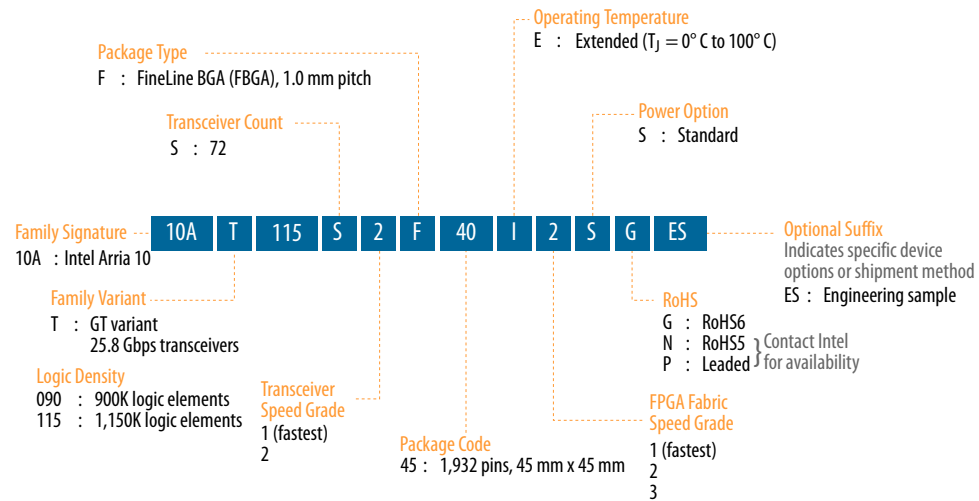
#### [Intel FPGA Product Selector](#)

Provides the latest information on Intel products.



## Available Options

Figure 2. Sample Ordering Code and Available Options for Intel Arria 10 GT Devices





### Related Information

I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.

## Intel Arria 10 SX

This section provides the available options, maximum resource counts, and package plan for the Intel Arria 10 SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Intel FPGA Product Selector.

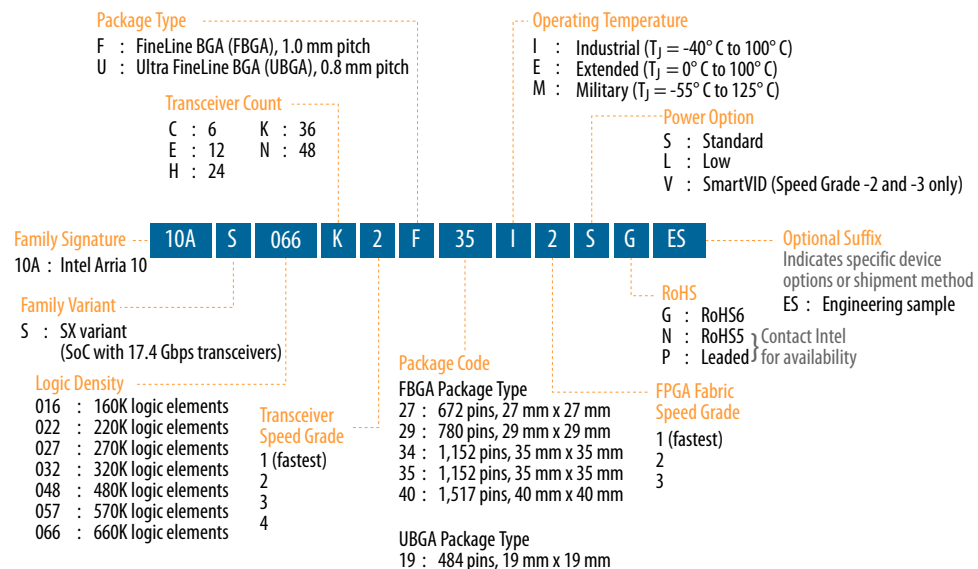
### Related Information

Intel FPGA Product Selector

Provides the latest information on Intel products.

## Available Options

**Figure 3. Sample Ordering Code and Available Options for Intel Arria 10 SX Devices**



### Related Information

Transceiver Performance for Intel Arria 10 GX/SX Devices

Provides more information about the transceiver speed grade.



## Maximum Resources

**Table 12. Maximum Resource Counts for Intel Arria 10 SX Devices**

| Resource                       |                      | Product Line |         |         |         |         |         |           |
|--------------------------------|----------------------|--------------|---------|---------|---------|---------|---------|-----------|
|                                |                      | SX 160       | SX 220  | SX 270  | SX 320  | SX 480  | SX 570  | SX 660    |
| Logic Elements (LE) (K)        |                      | 160          | 220     | 270     | 320     | 480     | 570     | 660       |
| ALM                            |                      | 61,510       | 80,330  | 101,620 | 119,900 | 183,590 | 217,080 | 251,680   |
| Register                       |                      | 246,040      | 321,320 | 406,480 | 479,600 | 734,360 | 868,320 | 1,006,720 |
| Memory (Kb)                    | M20K                 | 8,800        | 11,740  | 15,000  | 17,820  | 28,620  | 36,000  | 42,620    |
|                                | MLAB                 | 1,050        | 1,690   | 2,452   | 2,727   | 4,164   | 5,096   | 5,788     |
| Variable-precision DSP Block   |                      | 156          | 192     | 830     | 985     | 1,368   | 1,523   | 1,687     |
| 18 x 19 Multiplier             |                      | 312          | 384     | 1,660   | 1,970   | 2,736   | 3,046   | 3,374     |
| PLL                            | Fractional Synthesis | 6            | 6       | 8       | 8       | 12      | 16      | 16        |
|                                | I/O                  | 6            | 6       | 8       | 8       | 12      | 16      | 16        |
| 17.4 Gbps Transceiver          |                      | 12           | 12      | 24      | 24      | 36      | 48      | 48        |
| GPIO <sup>(8)</sup>            |                      | 288          | 288     | 384     | 384     | 492     | 696     | 696       |
| LVDS Pair <sup>(9)</sup>       |                      | 120          | 120     | 168     | 168     | 174     | 324     | 324       |
| PCIe Hard IP Block             |                      | 1            | 1       | 2       | 2       | 2       | 2       | 2         |
| Hard Memory Controller         |                      | 6            | 6       | 8       | 8       | 12      | 16      | 16        |
| ARM Cortex-A9 MPCore Processor |                      | Yes          | Yes     | Yes     | Yes     | Yes     | Yes     | Yes       |

## Package Plan

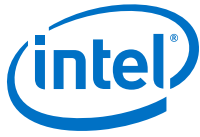
**Table 13. Package Plan for Intel Arria 10 SX Devices (U19, F27, F29, and F34)**

Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | U19<br>(19 mm × 19 mm,<br>484-pin UBGGA) |             |      | F27<br>(27 mm × 27 mm,<br>672-pin FBGA) |             |      | F29<br>(29 mm × 29 mm,<br>780-pin FBGA) |             |      | F34<br>(35 mm × 35 mm,<br>1152-pin FBGA) |             |      |
|--------------|--|-------------|------|---|-------------|------|---|-------------|------|--|-------------|------|
|              | 3 V<br>I/O                               | LVDS<br>I/O | XCVR | 3 V<br>I/O                              | LVDS<br>I/O | XCVR | 3 V<br>I/O                              | LVDS<br>I/O | XCVR | 3 V<br>I/O                               | LVDS<br>I/O | XCVR |
| SX 160       | 48                                       | 144         | 6    | 48                                      | 192         | 12   | 48                                      | 240         | 12   | —  | —           | —    |
| SX 220       | 48                                       | 144         | 6    | 48                                      | 192         | 12   | 48                                      | 240         | 12   | —  | —           | —    |
| SX 270       | —  | —           | —    | 48                                      | 192         | 12   | 48                                      | 312         | 12   | 48                                       | 336         | 24   |
| SX 320       | —  | —           | —    | 48                                      | 192         | 12   | 48                                      | 312         | 12   | 48                                       | 336         | 24   |
| continued... |  |             |      |   |             |      |   |             |      |  |             |      |

<sup>(8)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>(9)</sup> Each LVDS I/O pair can be used as differential input or output.



| Product Line | U19<br>(19 mm × 19 mm,<br>484-pin UBGA) |             |      | F27<br>(27 mm × 27 mm,<br>672-pin FBGA) |             |      | F29<br>(29 mm × 29 mm,<br>780-pin FBGA) |             |      | F34<br>(35 mm × 35 mm,<br>1152-pin FBGA) |             |      |
|--------------|---|-------------|------|---|-------------|------|---|-------------|------|--|-------------|------|
|              | 3 V<br>I/O                              | LVDS<br>I/O | XCVR | 3 V<br>I/O                              | LVDS<br>I/O | XCVR | 3 V<br>I/O                              | LVDS<br>I/O | XCVR | 3 V<br>I/O                               | LVDS<br>I/O | XCVR |
| SX 480       | —                                       | —           | —    | —                                       | —           | —    | 48                                      | 312         | 12   | 48                                       | 444         | 24   |
| SX 570       | —                                       | —           | —    | —                                       | —           | —    | —                                       | —           | —    | 48                                       | 444         | 24   |
| SX 660       | —                                       | —           | —    | —                                       | —           | —    | —                                       | —           | —    | 48                                       | 444         | 24   |

**Table 14. Package Plan for Intel Arria 10 SX Devices (F35, KF40, and NF40)**

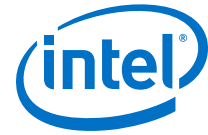
Refer to I/O and High Speed I/O in Intel Arria 10 Devices chapter for the number of 3 V I/O, LVDS I/O, and LVDS channels in each device package.

| Product Line | F35<br>(35 mm × 35 mm,<br>1152-pin FBGA) |          |      | KF40<br>(40 mm × 40 mm,<br>1517-pin FBGA) |          |      | NF40<br>(40 mm × 40 mm,<br>1517-pin FBGA) |          |      |
|--------------|--|----------|------|---|----------|------|---|----------|------|
|              | 3 V I/O                                  | LVDS I/O | XCVR | 3 V I/O                                   | LVDS I/O | XCVR | 3 V I/O                                   | LVDS I/O | XCVR |
| SX 270       | 48                                       | 336      | 24   | —   | —        | —    | —   | —        | —    |
| SX 320       | 48                                       | 336      | 24   | —   | —        | —    | —   | —        | —    |
| SX 480       | 48                                       | 348      | 36   | —   | —        | —    | —   | —        | —    |
| SX 570       | 48                                       | 348      | 36   | 96  | 600      | 36   | 48  | 540      | 48   |
| SX 660       | 48                                       | 348      | 36   | 96  | 600      | 36   | 48  | 540      | 48   |

#### Related Information

[I/O and High-Speed Differential I/O Interfaces in Intel Arria 10 Devices chapter, Intel Arria 10 Device Handbook](#)

Provides the number of 3 V and LVDS I/Os, and LVDS channels for each Intel Arria 10 device package.



## I/O Vertical Migration for Intel Arria 10 Devices

**Figure 4. Migration Capability Across Intel Arria 10 Product Lines**

- The arrows indicate the migration paths. The devices included in each vertical migration path are shaded. Devices with fewer resources in the same path have lighter shades.
- To achieve the full I/O migration across product lines in the same migration path, restrict I/Os and transceivers usage to match the product line with the lowest I/O and transceiver counts.
- An LVDS I/O bank in the source device may be mapped to a 3 V I/O bank in the target device. To use memory interface clock frequency higher than 533 MHz, assign external memory interface pins only to banks that are LVDS I/O in both devices.
- There may be nominal 0.15 mm package height difference between some product lines in the same package type.
- Some migration paths are not shown in the Intel Quartus Prime software **Pin Migration View**.

| Variant             | Product Line | Package |     |     |     |     |      |      |      |      |      |      |
|---------------------|--------------|---------|-----|-----|-----|-----|------|------|------|------|------|------|
|                     |              | U19     | F27 | F29 | F34 | F35 | KF40 | NF40 | RF40 | NF45 | SF45 | UF45 |
| Intel® Arria® 10 GX | GX 160       | ↑       | ↑   | ↑   |     |     |      |      |      |      |      |      |
|                     | GX 220       | ↓       | ↓   | ↓   |     |     |      |      |      |      |      |      |
|                     | GX 270       |         | ↓   | ↓   | ↑   | ↑   |      |      |      |      |      |      |
|                     | GX 320       |         | ↓   | ↓   | ↑   | ↑   |      |      |      |      |      |      |
|                     | GX 480       |         |     | ↓   | ↑   | ↑   |      |      |      |      |      |      |
|                     | GX 570       |         |     |     | ↑   | ↑   | ↑    | ↑    |      |      |      |      |
|                     | GX 660       |         |     |     | ↑   | ↑   | ↑    | ↑    | ↑    | ↑    | ↑    | ↑    |
|                     | GX 900       |         |     |     | ↑   |     |      | ↑    | ↑    | ↑    | ↑    | ↑    |
|                     | GX 1150      |         |     |     | ↑   |     |      | ↑    | ↑    | ↑    | ↑    | ↑    |
|                     | GT 900       |         |     |     |     |     |      |      |      |      | ↑    | ↑    |
|                     | GT 1150      |         |     |     |     |     |      |      |      |      | ↑    | ↑    |
| Intel Arria 10 GT   | GT 900       |         |     |     |     |     |      |      |      |      | ↑    | ↑    |
|                     | GT 1150      |         |     |     |     |     |      |      |      |      | ↑    | ↑    |
|                     | SX 160       | ↑       | ↑   | ↑   |     |     |      |      |      |      |      |      |
|                     | SX 220       | ↓       | ↓   | ↓   |     |     |      |      |      |      |      |      |
|                     | SX 270       |         | ↓   | ↓   | ↑   | ↑   |      |      |      |      |      |      |
|                     | SX 320       |         | ↓   | ↓   | ↑   | ↑   |      |      |      |      |      |      |
|                     | SX 480       |         |     | ↓   | ↑   | ↑   |      |      |      |      |      |      |
|                     | SX 570       |         |     |     | ↑   | ↑   | ↑    | ↑    |      |      |      |      |
| Intel Arria 10 SX   | SX 660       |         |     |     | ↑   | ↑   | ↑    | ↑    |      |      |      |      |

**Note:** To verify the pin migration compatibility, use the **Pin Migration View** window in the Intel Quartus Prime software Pin Planner.

## Adaptive Logic Module

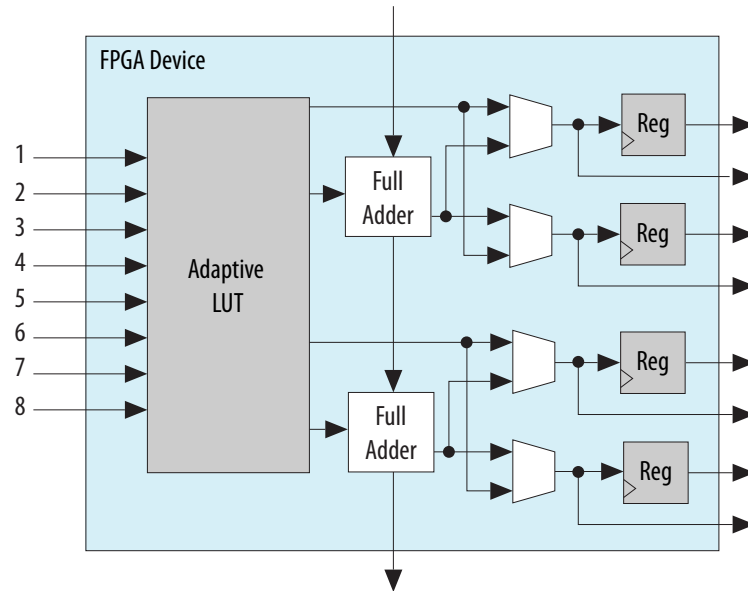
Intel Arria 10 devices use a 20 nm ALM as the basic building block of the logic fabric.

The ALM architecture is the same as the previous generation FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the device generations.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than the traditional two-register per LUT architecture.



**Figure 5. ALM for Intel Arria 10 Devices**



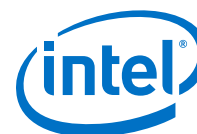
The Intel Quartus Prime software optimizes your design according to the ALM logic structure and automatically maps legacy designs into the Intel Arria 10 ALM architecture.

## Variable-Precision DSP Block

The Intel Arria 10 variable precision DSP blocks support fixed-point arithmetic and floating-point arithmetic.

Features for fixed-point arithmetic:

- High-performance, power-optimized, and fully registered multiplication operations
- 18-bit and 27-bit word lengths
- Two 18 x 19 multipliers or one 27 x 27 multiplier per DSP block
- Built-in addition, subtraction, and 64-bit double accumulation register to combine multiplication results
- Cascading 19-bit or 27-bit when pre-adder is disabled and cascading 18-bit when pre-adder is used to form the tap-delay line for filtering applications
- Cascading 64-bit output bus to propagate output results from one block to the next block without external logic support
- Hard pre-adder supported in 19-bit and 27-bit modes for symmetric filters
- Internal coefficient register bank in both 18-bit and 27-bit modes for filter implementation
- 18-bit and 27-bit systolic finite impulse response (FIR) filters with distributed output adder
- Biased rounding support



Features for floating-point arithmetic:

- A completely hardened architecture that supports multiplication, addition, subtraction, multiply-add, and multiply-subtract
- Multiplication with accumulation capability and a dynamic accumulator reset control
- Multiplication with cascade summation capability
- Multiplication with cascade subtraction capability
- Complex multiplication
- Direct vector dot product
- Systolic FIR filter

**Table 15. Variable-Precision DSP Block Configurations for Intel Arria 10 Devices**

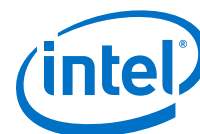
| Usage Example   | Multiplier Size (Bit)           | DSP Block Resources |
|---|---------------------------------|---------------------|
| Medium precision fixed point                            | Two 18 x 19                     | 1                   |
| High precision fixed or Single precision floating point | One 27 x 27                     | 1                   |
| Fixed point FFTs  | One 19 x 36 with external adder | 1                   |
| Very high precision fixed point                         | One 36 x 36 with external adder | 2                   |
| Double precision floating point                         | One 54 x 54 with external adder | 4                   |

**Table 16. Resources for Fixed-Point Arithmetic in Intel Arria 10 Devices**

The table lists the variable-precision DSP resources by bit precision for each Intel Arria 10 device.

| Variant           | Product Line | Variable-precision DSP Block | Independent Input and Output Multiplications Operator |                    | 18 x 19 Multiplier Adder Sum Mode | 18 x 18 Multiplier Adder Summed with 36 bit Input |
|-------------------|--------------|------------------------------|---|--------------------|-----------------------------------|---|
|                   |              |                              | 18 x 19 Multiplier                                    | 27 x 27 Multiplier |                                   |   |
| Intel Arria 10 GX | GX 160       | 156                          | 312   | 156                | 156                               | 156   |
|                   | GX 220       | 192                          | 384   | 192                | 192                               | 192   |
|                   | GX 270       | 830                          | 1,660   | 830                | 830                               | 830   |
|                   | GX 320       | 984                          | 1,968   | 984                | 984                               | 984   |
|                   | GX 480       | 1,368                        | 2,736   | 1,368              | 1,368                             | 1,368   |
|                   | GX 570       | 1,523                        | 3,046   | 1,523              | 1,523                             | 1,523   |
|                   | GX 660       | 1,687                        | 3,374   | 1,687              | 1,687                             | 1,687   |
|                   | GX 900       | 1,518                        | 3,036   | 1,518              | 1,518                             | 1,518   |
|                   | GX 1150      | 1,518                        | 3,036   | 1,518              | 1,518                             | 1,518   |
| Intel Arria 10 GT | GT 900       | 1,518                        | 3,036   | 1,518              | 1,518                             | 1,518   |
|                   | GT 1150      | 1,518                        | 3,036   | 1,518              | 1,518                             | 1,518   |
| Intel Arria 10 SX | SX 160       | 156                          | 312   | 156                | 156                               | 156   |
|                   | SX 220       | 192                          | 384   | 192                | 192                               | 192   |
|                   | SX 270       | 830                          | 1,660   | 830                | 830                               | 830   |

*continued...*



## Types of Embedded Memory

The Intel Arria 10 devices contain two types of memory blocks:

- 20 Kb M20K blocks—blocks of dedicated memory resources. The M20K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide and shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Intel Arria 10 devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.

## Embedded Memory Capacity in Intel Arria 10 Devices

**Table 18. Embedded Memory Capacity and Distribution in Intel Arria 10 Devices**

| Variant           | Product Line | M20K  |              | MLAB   |              | Total RAM Bit (Kb) |
|-------------------|--------------|-------|--------------|--------|--------------|--------------------|
|                   |              | Block | RAM Bit (Kb) | Block  | RAM Bit (Kb) |                    |
| Intel Arria 10 GX | GX 160       | 440   | 8,800        | 1,680  | 1,050        | 9,850              |
|                   | GX 220       | 587   | 11,740       | 2,703  | 1,690        | 13,430             |
|                   | GX 270       | 750   | 15,000       | 3,922  | 2,452        | 17,452             |
|                   | GX 320       | 891   | 17,820       | 4,363  | 2,727        | 20,547             |
|                   | GX 480       | 1,431 | 28,620       | 6,662  | 4,164        | 32,784             |
|                   | GX 570       | 1,800 | 36,000       | 8,153  | 5,096        | 41,096             |
|                   | GX 660       | 2,131 | 42,620       | 9,260  | 5,788        | 48,408             |
|                   | GX 900       | 2,423 | 48,460       | 15,017 | 9,386        | 57,846             |
|                   | GX 1150      | 2,713 | 54,260       | 20,774 | 12,984       | 67,244             |
| Intel Arria 10 GT | GT 900       | 2,423 | 48,460       | 15,017 | 9,386        | 57,846             |
|                   | GT 1150      | 2,713 | 54,260       | 20,774 | 12,984       | 67,244             |
| Intel Arria 10 SX | SX 160       | 440   | 8,800        | 1,680  | 1,050        | 9,850              |
|                   | SX 220       | 587   | 11,740       | 2,703  | 1,690        | 13,430             |
|                   | SX 270       | 750   | 15,000       | 3,922  | 2,452        | 17,452             |
|                   | SX 320       | 891   | 17,820       | 4,363  | 2,727        | 20,547             |
|                   | SX 480       | 1,431 | 28,620       | 6,662  | 4,164        | 32,784             |
|                   | SX 570       | 1,800 | 36,000       | 8,153  | 5,096        | 41,096             |
|                   | SX 660       | 2,131 | 42,620       | 9,260  | 5,788        | 48,408             |

- Series ( $R_S$ ) and parallel ( $R_T$ ) on-chip termination (OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture

## External Memory Interface

Intel Arria 10 devices offer massive external memory bandwidth, with up to seven 32-bit DDR4 memory interfaces running at up to 2,400 Mbps. This bandwidth provides additional ease of design, lower power, and resource efficiencies of hardened high-performance memory controllers.

The memory interface within Intel Arria 10 FPGAs and SoCs delivers the highest performance and ease of use. You can configure up to a maximum width of 144 bits when using the hard or soft memory controllers. If required, you can bypass the hard memory controller and use a soft controller implemented in the user logic.

Each I/O contains a hardened DDR read/write path (PHY) capable of performing key memory interface functionality such as read/write leveling, FIFO buffering to lower latency and improve margin, timing calibration, and on-chip termination.

The timing calibration is aided by the inclusion of hard microcontrollers based on Intel's Nios® II technology, specifically tailored to control the calibration of multiple memory interfaces. This calibration allows the Intel Arria 10 device to compensate for any changes in process, voltage, or temperature either within the Intel Arria 10 device itself, or within the external memory device. The advanced calibration algorithms ensure maximum bandwidth and robust timing margin across all operating conditions.

In addition to parallel memory interfaces, Intel Arria 10 devices support serial memory technologies such as the Hybrid Memory Cube (HMC). The HMC is supported by the Intel Arria 10 high-speed serial transceivers which connect up to four HMC links, with each link running at data rates up to 15 Gbps.

### Related Information

#### [External Memory Interface Spec Estimator](#)

Provides a parametric tool that allows you to find and compare the performance of the supported external memory interfaces in IntelFPGAs.

## Memory Standards Supported by Intel Arria 10 Devices

The I/Os are designed to provide high performance support for existing and emerging external memory standards.



The scalable hard IP supports multiple independent 10GbE ports while using a single PLL for all the 10GBASE-R PCS instantiations, which saves on core logic resources and clock networks:

- Simplifies multiport 10GbE systems compared to XAUI interfaces that require an external XAUI-to-10G PHY.
- Incorporates Electronic Dispersion Compensation (EDC), which enables direct connection to standard 10 Gbps XFP and SFP+ pluggable optical modules.
- Supports backplane Ethernet applications and includes a hard 10GBASE-KR Forward Error Correction (FEC) circuit that you can use for 10 Gbps and 40 Gbps applications.

The 10 Gbps Ethernet PCS hard IP and 10GBASE-KR FEC are present in every transceiver channel.

#### **Related Information**

[PCS Features](#) on page 30

## **Low Power Serial Transceivers**

Intel Arria 10 FPGAs and SoCs include lowest power transceivers that deliver high bandwidth, throughput and low latency.

Intel Arria 10 devices deliver the industry's lowest power consumption per transceiver channel:

- 12.5 Gbps transceivers at as low as 242 mW
- 10 Gbps transceivers at as low as 168 mW
- 6 Gbps transceivers at as low as 117 mW

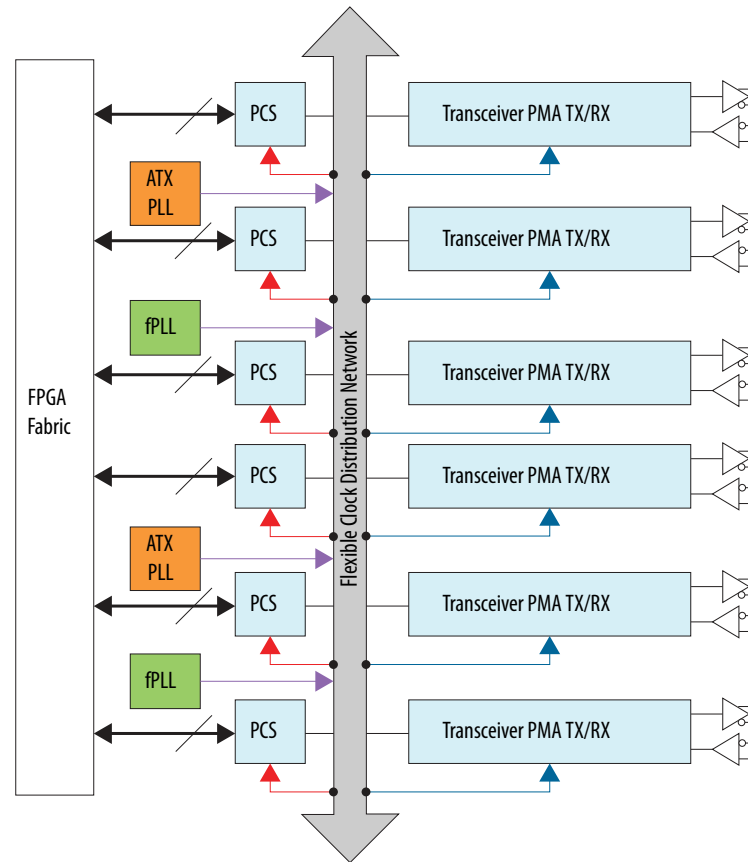
Intel Arria 10 transceivers support various data rates according to application:

- Chip-to-chip and chip-to-module applications—from 1 Gbps up to 25.8 Gbps
- Long reach and backplane applications—from 1 Gbps up to 12.5 with advanced adaptive equalization
- Critical power sensitive applications—from 1 Gbps up to 11.3 Gbps using lower power modes

The combination of 20 nm process technology and architectural advances provide the following benefits:

- Significant reduction in die area and power consumption
- Increase of up to two times in transceiver I/O density compared to previous generation devices while maintaining optimal signal integrity
- Up to 72 total transceiver channels—you can configure up to 6 of these channels to run as fast as 25.8 Gbps
- All channels feature continuous data rate support up to the maximum rated speed

Figure 6. Intel Arria 10 Transceiver Block Architecture



## Transceiver Channels

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other pre-processing functions before transferring data to the FPGA core fabric.

A transceiver channel consists of a PMA and a PCS block. Most transceiver banks have 6 channels. There are some transceiver banks that contain only 3 channels.

A wide variety of bonded and non-bonded data rate configurations is possible using a highly configurable clock distribution network. Up to 80 independent transceiver data rates can be configured.

The following figures are graphical representations of top views of the silicon die, which correspond to reverse views for flip chip packages. Different Intel Arria 10 devices may have different floorplans than the ones shown in the figures.



Figure 7. Device Chip Overview for Intel Arria 10 GX and GT Devices

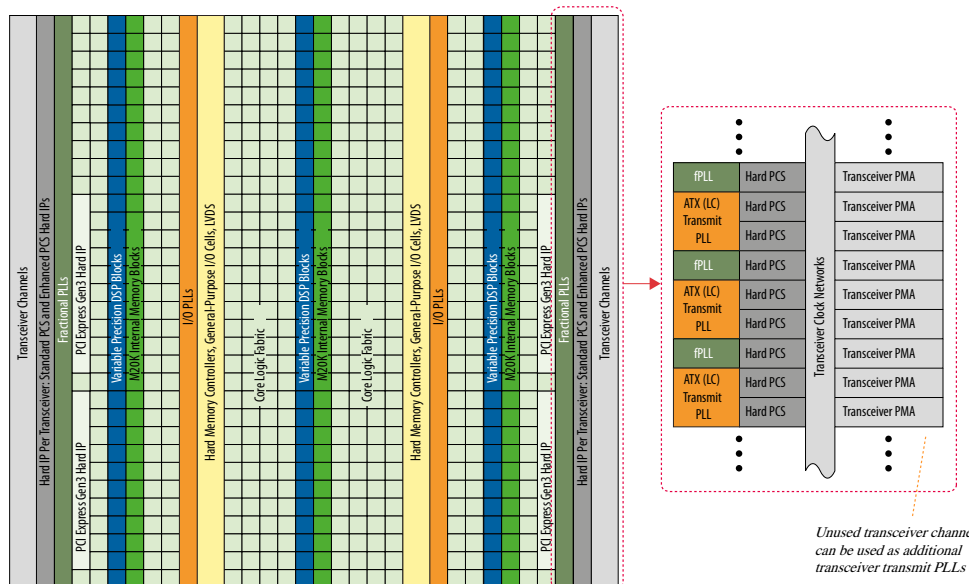
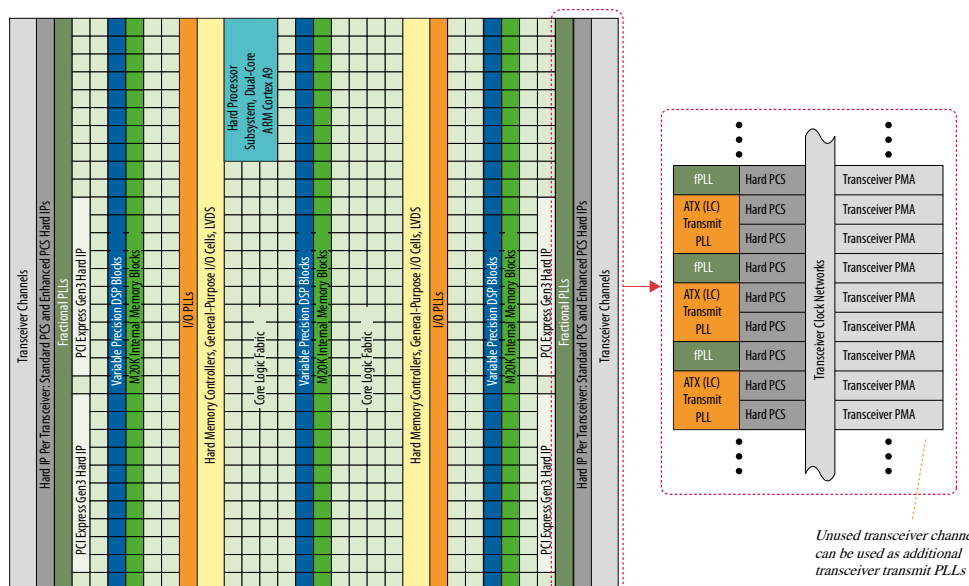


Figure 8. Device Chip Overview for Intel Arria 10 SX Devices



## PMA Features

Intel Arria 10 transceivers provide exceptional signal integrity at data rates up to 25.8 Gbps. Clocking options include ultra-low jitter ATX PLLs (LC tank based), clock multiplier unit (CMU) PLLs, and fractional PLLs.



| PCS           | Description  |
|---------------|--|
| Standard PCS  | <ul style="list-style-type: none"> <li>Operates at a data rate up to 12 Gbps</li> <li>Supports protocols such as PCI-Express, CPRI 4.2+, GigE, IEEE 1588 in Hard PCS</li> <li>Implements other protocols using Basic/Custom (Standard PCS) transceiver configuration rules.</li> </ul>   |
| Enhanced PCS  | <ul style="list-style-type: none"> <li>Performs functions common to most serial data industry standards, such as word alignment, encoding/decoding, and framing, before data is sent or received off-chip through the PMA</li> <li>Handles data transfer to and from the FPGA fabric</li> <li>Handles data transfer internally to and from the PMA</li> <li>Provides frequency compensation</li> <li>Performs channel bonding for multi-channel low skew applications</li> </ul> |
| PCIe Gen3 PCS | <ul style="list-style-type: none"> <li>Supports the seamless switching of Data and Clock between the Gen1, Gen2, and Gen3 data rates</li> <li>Provides support for PIPE 3.0 features</li> <li>Supports the PIPE interface with the Hard IP enabled, as well as with the Hard IP bypassed</li> </ul>  |

### Related Information

- [PCIe Gen1, Gen2, and Gen3 Hard IP](#) on page 26
- [Interlaken Support](#) on page 26
- [10 Gbps Ethernet Support](#) on page 26

## PCS Protocol Support

This table lists some of the protocols supported by the Intel Arria 10 transceiver PCS. For more information about the blocks in the transmitter and receiver data paths, refer to the related information.

| Protocol                                     | Data Rate (Gbps) | Transceiver IP              | PCS Support                    |
|--|------------------|-----------------------------|--------------------------------|
| PCIe Gen3 x1, x2, x4, x8                     | 8.0              | Native PHY (PIPE)           | Standard PCS and PCIe Gen3 PCS |
| PCIe Gen2 x1, x2, x4, x8                     | 5.0              | Native PHY (PIPE)           | Standard PCS                   |
| PCIe Gen1 x1, x2, x4, x8                     | 2.5              | Native PHY (PIPE)           | Standard PCS                   |
| 1000BASE-X Gigabit Ethernet                  | 1.25             | Native PHY                  | Standard PCS                   |
| 1000BASE-X Gigabit Ethernet with IEEE 1588v2 | 1.25             | Native PHY                  | Standard PCS                   |
| 10GBASE-R                                    | 10.3125          | Native PHY                  | Enhanced PCS                   |
| 10GBASE-R with IEEE 1588v2                   | 10.3125          | Native PHY                  | Enhanced PCS                   |
| 10GBASE-R with KR FEC                        | 10.3125          | Native PHY                  | Enhanced PCS                   |
| 10GBASE-KR and 1000BASE-X                    | 10.3125          | 1G/10GbE and 10GBASE-KR PHY | Standard PCS and Enhanced PCS  |
| Interlaken (CEI-6G/11G)                      | 3.125 to 17.4    | Native PHY                  | Enhanced PCS                   |
| SFI-S/SFI-5.2                                | 11.2             | Native PHY                  | Enhanced PCS                   |
| 10G SDI                                      | 10.692           | Native PHY                  | Enhanced PCS                   |
| continued...                                 |                  |                             |                                |



## System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.

## HPS-FPGA AXI Bridges

The HPS-FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA) Advanced eXtensible Interface (AXI™) specifications, consist of the following bridges:

- FPGA-to-HPS AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA Avalon/AMBA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to soft peripherals in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

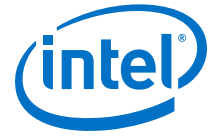
Each HPS-FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

## HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

The HPS SDRAM controller supports up to 3 masters (command ports), 3x 64-bit read data ports and 3x 64-bit write data ports.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features.



## FPGA Configuration and HPS Booting

The FPGA fabric and HPS in the SoC FPGA must be powered at the same time. You can reduce the clock frequencies or gate the clocks to reduce dynamic power.

Once powered, the FPGA fabric and HPS can be configured independently thus providing you with more design flexibility:

- You can boot the HPS independently. After the HPS is running, the HPS can fully or partially reconfigure the FPGA fabric at any time under software control. The HPS can also configure other FPGAs on the board through the FPGA configuration controller.
- Configure the FPGA fabric first, and then boot the HPS from memory accessible to the FPGA fabric.

## Hardware and Software Development

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer system integration tool in the Intel Quartus Prime software.

For software development, the ARM-based SoC FPGA devices inherit the rich software development ecosystem available for the ARM Cortex-A9 MPCore processor. The software development process for Intel SoC FPGAs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux\*, VxWorks\*, and other operating systems are available for the SoC FPGAs. For more information on the operating systems support availability, contact the Intel FPGA sales team.

You can begin device-specific firmware and software development on the Intel SoC FPGA Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

## Dynamic and Partial Reconfiguration

The Intel Arria 10 devices support dynamic and partial reconfiguration. You can use dynamic and partial reconfiguration simultaneously to enable seamless reconfiguration of both the device core and transceivers.

### Dynamic Reconfiguration

You can reconfigure the PMA and PCS blocks while the device continues to operate. This feature allows you to change the data rates, protocol, and analog settings of a channel in a transceiver bank without affecting on-going data transfer in other transceiver banks. This feature is ideal for applications that require dynamic multiprotocol or multirate support.

### Partial Reconfiguration

Using partial reconfiguration, you can reconfigure some parts of the device while keeping the device in operation.



The optional power reduction techniques in Intel Arria 10 devices include:

- **SmartVID**—a code is programmed into each device during manufacturing that allows a smart regulator to operate the device at lower core  $V_{CC}$  while maintaining performance
- **Programmable Power Technology**—non-critical timing paths are identified by the Intel Quartus Prime software and the logic in these paths is biased for low power instead of high performance
- **Low Static Power Options**—devices are available with either standard static power or low static power while maintaining performance

Furthermore, Intel Arria 10 devices feature Intel's industry-leading low power transceivers and include a number of hard IP blocks that not only reduce logic resources but also deliver substantial power savings compared to soft implementations. In general, hard IP blocks consume up to 90% less power than the equivalent soft logic implementations.

## Incremental Compilation

The Intel Quartus Prime software incremental compilation feature reduces compilation time and helps preserve performance to ease timing closure. The incremental compilation feature enables the partial reconfiguration flow for Intel Arria 10 devices.

Incremental compilation supports top-down, bottom-up, and team-based design flows. This feature facilitates modular, hierarchical, and team-based design flows where different designers compile their respective design sections in parallel. Furthermore, different designers or IP providers can develop and optimize different blocks of the design independently. These blocks can then be imported into the top level project.

## Document Revision History for Intel Arria 10 Device Overview

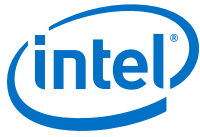
| Document Version | Changes  |
|------------------|--|
| 2018.04.09       | Updated the lowest $V_{CC}$ from 0.83 V to 0.82 V in the topic listing a summary of the device features. |

| Date         | Version    | Changes   |
|--------------|------------|---|
| January 2018 | 2018.01.17 | <ul style="list-style-type: none"><li>• Updated the maximum data rate for HPS (Intel Arria 10 SX devices external memory interface DDR3 controller from 2,166 Mbps to 2,133 Mbps.</li><li>• Updated maximum frequency supported for half rate QDR II and QDR II + SRAM to 633 MHz in <i>Memory Standards Supported by the Soft Memory Controller</i> table.</li><li>• Updated transceiver backplane capability to 12.5 Gbps.</li><li>• Removed transceiver speed grade 5 in <i>Sample Ordering Core and Available Options for Intel Arria 10 GX Devices</i> figure.</li></ul> |
| continued... |            |   |



| Date           | Version    | Changes  |
|----------------|------------|--|
|                |            | <ul style="list-style-type: none"> <li>Removed package code 40, low static power, SmartVID, industrial, and military operating temperature support from <i>Sample Ordering Core and Available Options for Intel Arria 10 GT Devices</i> figure.</li> <li>Updated short reach transceiver rate for Intel Arria 10 GT devices to 25.8 Gbps.</li> <li>Removed On-Die Instrumentation — EyeQ and Jitter Margin Tool support from <i>PMA Features of the Transceivers in Intel Arria 10 Devices</i> table.</li> </ul>   |
| September 2017 | 2017.09.20 | Updated the maximum speed of the DDR4 external memory interface from 1,333 MHz/2,666 Mbps to 1,200 MHz/2,400 Mbps.   |
| July 2017      | 2017.07.13 | Corrected the automotive temperature range in the figure showing the available options for the Intel Arria 10 GX devices from "-40°C to 100°C" to "-40°C to 125°C".  |
| July 2017      | 2017.07.06 | Added automotive temperature option to Intel Arria 10 GX device family.  |
| May 2017       | 2017.05.08 | <ul style="list-style-type: none"> <li>Corrected protocol names with "1588" to "IEEE 1588v2".</li> <li>Updated the vertical migration table to remove vertical migration between Intel Arria 10 GX and Intel Arria 10 SX device variants.</li> <li>Removed all "Preliminary" marks.</li> </ul>   |
| March 2017     | 2017.03.15 | <ul style="list-style-type: none"> <li>Removed the topic about migration from Intel Arria 10 to Intel Stratix 10 devices.</li> <li>Rebranded as Intel.</li> </ul>  |
| October 2016   | 2016.10.31 | <ul style="list-style-type: none"> <li>Removed package F36 from Intel Arria 10 GX devices.</li> <li>Updated Intel Arria 10 GT sample ordering code and maximum GX transceiver count. Intel Arria 10 GT devices are available only in the SF45 package option with a maximum of 72 transceivers.</li> </ul>   |
| May 2016       | 2016.05.02 | <ul style="list-style-type: none"> <li>Updated the FPGA Configuration and HPS Booting topic.</li> <li>Remove V<sub>CC</sub> PowerManager from the Summary of Features, Power Management and Arria 10 Device Variants and packages topics. This feature is no longer supported in Arria 10 devices.</li> <li>Removed LPDDR3 from the Memory Standards Supported by the HPS Hard Memory Controller table in the Memory Standards Supported by Intel Arria 10 Devices topic. This standard is only supported by the FPGA.</li> <li>Removed transceiver speed grade 5 from the Device Variants and Packages topic for Arria 10 GX and SX devices.</li> </ul>   |
| February 2016  | 2016.02.11 | <ul style="list-style-type: none"> <li>Changed the maximum Arria 10 GT datarate to 25.8 Gbps and the minimum datarate to 1 Gbps globally.</li> <li>Revised the state for Core clock networks in the Summary of Features topic.</li> <li>Changed the transceiver parameters in the "Summary of Features for Arria 10 Devices" table.</li> <li>Changed the transceiver parameters in the "Maximum Resource Counts for Arria 10 GT Devices" table.</li> <li>Changed the package availability for GT devices in the "Package Plan for Arria 10 GT Devices" table.</li> <li>Changed the package configurations for GT devices in the "Migration Capability Across Arria 10 Product Lines" figure.</li> <li>Changed transceiver parameters in the "Low Power Serial Transceivers" section.</li> <li>Changed the transceiver descriptions in the "Device Variants for the Arria 10 Device Family" table.</li> <li>Changed the "Sample Ordering Code and Available Options for Arria 10 GT Devices" figure.</li> <li>Changed the datarates for GT devices in the "PMA Features" section.</li> <li>Changed the datarates for GT devices in the "PCS Features" section.</li> </ul> |

continued...



| Date           | Version    | Changes   |
|----------------|------------|---|
| December 2015  | 2015.12.14 | <ul style="list-style-type: none"><li>Updated the number of M20K memory blocks for Arria 10 GX 660 from 2133 to 2131 and corrected the total RAM bit from 48,448 Kb to 48,408 Kb.</li><li>Corrected the number of DSP blocks for Arria 10 GX 660 from 1688 to 1687 in the table listing floating-point arithmetic resources.</li></ul>  |
| November 2015  | 2015.11.02 | <ul style="list-style-type: none"><li>Updated the maximum resources for Arria 10 GX 220, GX 320, GX 480, GX 660, SX 220, SX 320, SX 480, and SX 660.</li><li>Updated resource count for Arria 10 GX 320, GX 480, GX 660, SX 320, SX 480, a SX 660 devices in <b>Number of Multipliers in Intel Arria 10 Devices</b> table.</li><li>Updated the available options for Arria 10 GX, GT, and SX.</li><li>Changed instances of <i>Quartus II</i> to <i>Quartus Prime</i>.</li></ul>   |
| June 2015      | 2015.06.15 | Corrected label for Intel Arria 10 GT product lines in the vertical migration figure.   |
| May 2015       | 2015.05.15 | Corrected the DDR3 half rate and quarter rate maximum frequencies in the table that lists the memory standards supported by the Intel Arria 10 hard memory controller.  |
| May 2015       | 2015.05.04 | <ul style="list-style-type: none"><li>Added support for 13.5G JESD204b in the Summary of Features table.</li><li>Added a link to Arria 10 GT Channel Usage in the Arria 10 GT Package Plan topic.</li><li>Added a note to the table, Maximum Resource Counts for Arria 10 GT devices.</li><li>Updated the power requirements of the transceivers in the Low Power Serial Transceivers topic.</li></ul>  |
| January 2015   | 2015.01.23 | <ul style="list-style-type: none"><li>Added floating point arithmetic features in the Summary of Features table.</li><li>Updated the total embedded memory from 38.38 megabits (Mb) to 65.6 Mb.</li><li>Updated the table that lists the memory standards supported by Intel Arria 10 devices.</li><li>Removed support for DDR3U, LPDDR3 SDRAM, RLD RAM 2, and DDR2.</li><li>Moved RLD RAM 3 support from hard memory controller to soft memory controller. RLD RAM 3 support uses hard PHY with soft memory controller.</li><li>Added soft memory controller support for QDR IV.</li><li>Updated the maximum resource count table to include the number of hard memory controllers available in each device variant.</li><li>Updated the transceiver PCS data rate from 12.5 Gbps to 12 Gbps.</li><li>Updated the max clock rate of PS, FPP x8, FPP x16, and Configuration via HPS from 125 MHz to 100 MHz.</li><li>Added a feature for fractional synthesis PLLs: PLL cascading.</li><li>Updated the HPS programmable general-purpose I/Os from 54 to 62.</li></ul> |
| September 2014 | 2014.09.30 | <ul style="list-style-type: none"><li>Corrected the 3 V I/O and LVDS I/O counts for F35 and F36 packages of Arria 10 GX.</li><li>Corrected the 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 570 and 660.</li><li>Removed 3 V I/O, LVDS I/O, and transceiver counts for the NF40 package of the Arria GX 900 and 1150. The NF40 package is not available for Arria 10 GX 900 and 1150.</li></ul>   |
| continued...   |            |   |